T-P INS 2 — ELECTRICALLY INSULATING, THERMALLY

CONDUCTIVE INTERFACE MATERIAL



DATASHEET



T-P INS 2

FEATURES

- · High tensile strength, designed to prevent cut through and electrical shorts
- · Low Thermal Impedance
- · UL94-V0 recognised
- · No viscosity, 0.18mm thick
- · Naturally tacky on both sides

APPLICATIONS

· SMPS, Telecom Devices, Visual Devices, Networking Products, LCD-TV, Notebook PC's, PC's, ME, Household Applications etc.

	PROPERTIES	TEST METHOD			UNIT	JNIT T-P-INS 2	
	Material	-			Thermally Conductive Silicon Cloth		Silicon
	Colour	Visual			-	Blue	
	Thickness (±10%)		-		-	0.2	
	Thermal Conductivity	ASTM-D5470			W/mK	1.8	
	Hardness (±5)	ASTM-D2240			-	75	
	Flammability Rating	UL94			-	VO	
	Breakdown Voltage	ASTM-D149			kV	≥7.5	
	Specific Gravity	-			g/cm³	2.34	
	Working Temperature	-			°C	-40 - 200	
	Volume Resistance	ASTM-D257			Ohm-cm	10 ¹²	
	Tensile Strength	ASTM-D412-1998A			Мра	0.8	
THERMAL IMPEDANCE							
	Pressure (psi)	5	10	15	20	25	30
	Thickness (mm)	0.2	0.19	0.19	0.19	0.19	0.19

NOTES

0

0.36

- · Customised shapes are available
- The above performance data is tested in an environment of 70% humidity, temperature 25 °C

5

0.33

· This data is intended for reference purposes only. It is recommended that the material is tested to fully evaluate its performance ensuring it is fit for purpose.

5

0.32

5

0.32

5

0.31

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Compression Ration (%)

Thermal Impedance (C-in²/W)

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5

0.34